2.5V Drive Pch+SBD MOSFET

US5U38

Structure

Silicon P-channel MOSFET Schottky Barrier DIODE

● Features

- 1) The US5U38 combines Pch MOSFET with a Schottky barrier diode in a TUMT5 package.
- 2) Low on-resistance with fast switching.
- 3) Low voltage drive (2.5V).
- 4) Built-in schottky barrier diode has low forward voltage.

Applications

Switching

Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
US5U38		0

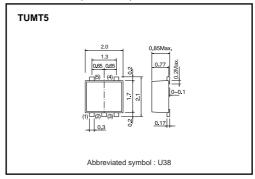
● Absolute maximum ratings (Ta=25°C)

<MOSFET>

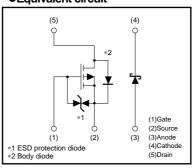
Parameter		Symbol	Limits	Unit		
Drain-source voltage	V _{DSS}	-20	V			
Gate-source voltage	Vgss	±12	V			
Drain current	Continuous	I _D	±1.0	А		
	Pulsed	I _{DP} *1	±4.0	Α		
Source current	Continuous	Is	-0.4	Α		
(Body diode)	Pulsed	Isp *1	-4.0	Α		
Channel temperature	Channel temperature			°C		
Power dissipation	P _D *3	0.7	W / ELEMENT			
<di></di>						
Repetitive peak reverse volta	V_{RM}	25	V			
Reverse voltage	V_R	20	V			
Forward current	lF	0.7	Α			
Forward current surge peak	I _{FSM} *2	3.0	Α			
Junction temperature	Tj	150	°C			
Power dissipation	P _D *3	0.5	W / ELEMENT			
<mosfet and="" di=""></mosfet>						
Power dissipation	P _D *3	1.0	W / TOTAL			
Range of storage temperatu	Tstg	-55 to +150	°C			

^{*1} Pw≤10μs, Duty cycle≤1% *2 60Hz•1cyc. *3 Mounted on a ceramic board

●Dimensions (Unit: mm)



●Equivalent circuit



Transistor

●Electrical characteristics (Ta=25°C)

<MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	-	±10	μА	Vgs=±12V, Vps=0V
Drain-source breakdown voltage	V(BR) DSS	-20	_	_	٧	ID=-1mA, VGS=0V
Zero gate voltage drain current	IDSS	-	-	-1	μΑ	V _{DS} =-20V, V _{GS} =0V
Gate threshold voltage	VGS (th)	-0.7	_	-2.0	V	Vps=-10V, Ip=-1mA
Static drain-source on-state resistance	*	-	280	390	mΩ	In=-1A, Vgs=-4.5V
	RDS (on)	-	310	430	mΩ	In=-1A, Vgs=-4.0V
		-	570	800	mΩ	ID=-0.5A, VGS=-2.5V
Forward transfer admittance	Y _{fs} *	0.7	_	_	S	VDS=-10V, ID=-0.5A
Input capacitance	Ciss	_	150	_	pF	Vps=-10V
Output capacitance	Coss	_	20	_	pF	V _G s=0V
Reverse transfer capacitance	Crss	_	20	_	pF	f=1MHz
Turn-on delay time	td (on) *	_	9	_	ns	ID=-0.5A
Rise time	tr *	_	8	_	ns	VDD≒-15V VGS=-4.5V
Turn-off delay time	td (off) *	_	25	_	ns	$R_{\perp} = 30\Omega$
Fall time	t _f *	-	10	_	ns	R _G =10Ω
Total gate charge	Qg *	-	2.1	_	nC	ID=-1A, VDD≒-15V
Gate-source charge	Qgs *	-	0.5	_	nC	Vgs=-4.5V
Gate-drain charge	Q _{gd} *	_	0.5	_	nC	$R_L = 15\Omega$, $R_G = 10\Omega$

^{*} Pulsed

<Body diode (source-drain)>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	_	_	-1.2	٧	Is=-0.4A, Vgs=0V

<Di>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	_	_	0.49	V	I==0.7A
Reverse current	lR	_	_	200	μΑ	V _R =20V

•Electrical characteristic curves

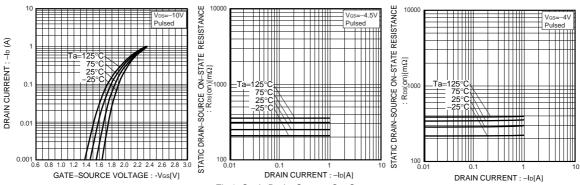
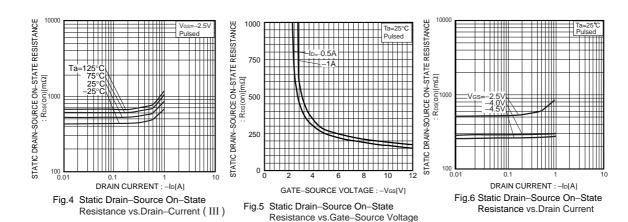
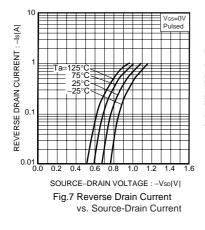
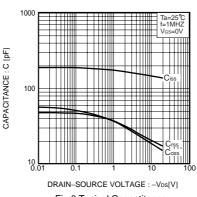


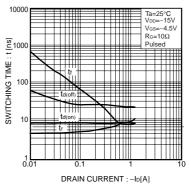
Fig.1 Typical Transfer Characteristics Fig.2 Static Drain–Source On–State Resistance vs.Drain Current (I)

Fig.3 Static Drain-Source On-State Resistance vs.Drain Current (II)









DRAIN-SOURCE VOLTAGE: -Vos[V]
Fig.8 Typical Capactitance
vs.Drain-Source Voltage

Fig.9 Switching Characteristics

Transistor

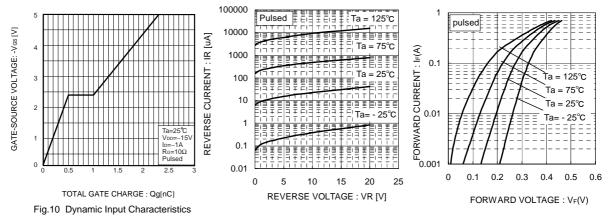


Fig.11 Reverse Current vs. Reverse Voltage

Fig.12 Forward Current vs. Forward Voltage

Notice

- 1. SBD has a large reverse leak current compared to other type of diode. Therefore; it would raise a junction temperature, and increase a reverse power loss. Further rise of inside temperature would cause a thermal runaway.
 This built-in SBD has low V_F characteristics and therefore, higher leak current. Please consider enough the surrounding temperature, generating heat of MOSFET and the reverse current.
- 2. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

Measurement circuits

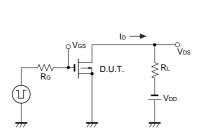


Fig.13 Switching Time Measurement Circuit

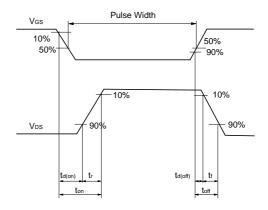


Fig.14 Switching Waveforms

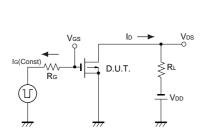


Fig.15 Gate Charge Measurement Circuit

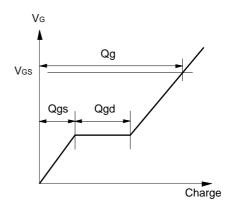


Fig.16 Gate Charge Waveforms

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